

# **SCMM2512S6** Series, Current Sensor Resistor (Lead / Halogen Free)

# The history of revision change for the specification

Date	Revision	Changes	
2021/11/30	A0	New Approval standard (POYIN)	
2022/3/8	A1	Add resistance 0.75 and modify diagram without marking (POYIN)	
2022/4/7	A2	Modify solder pad and change L as I (POYIN)	
2022/4/18	А3	Add marking (YT)	
2022/7/11	A4	Add two descriptions of care note for storage of Care note (CH)	
2023/2/23	A5	Remove ESD test item (CH)	

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## SCMM2512S6 Series, Current Sensor Resistor (Lead / Halogen Free)

## Features / Applications :

- High power rating is up to 6W
- Welding construction; excellent long-term stability
- Industrial applications & Current Sensor Resistor
- Suggested mounting on DBC/IMS/FR4 substrate
- RoHS compliant



## **Electrical Specifications:**

Characteristics <sup>1</sup>	Feature
Power Rating <sup>2</sup>	6 W
Resistance Value	0.3 to 1 m $\Omega$
Temperature Coefficient of Resistance (25/125°C)	From 50 ppm/°C
Operation Temperature Range	-65°C∼ +170°C
Resistance Tolerance	± 1%
Maximum Working Voltage (V)	(P*R) <sup>1/2</sup>

- 1. For detail information refer to the table on page 3 P/N list
- 2. For resistors are operated at terminal temperature in excess of 100°C, the maximum load shall be derated in accordance with the following curve.

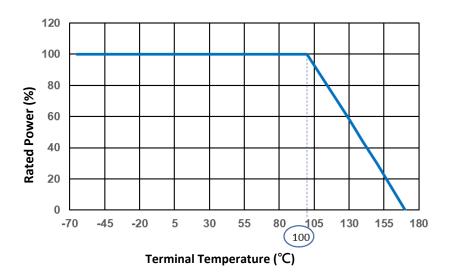


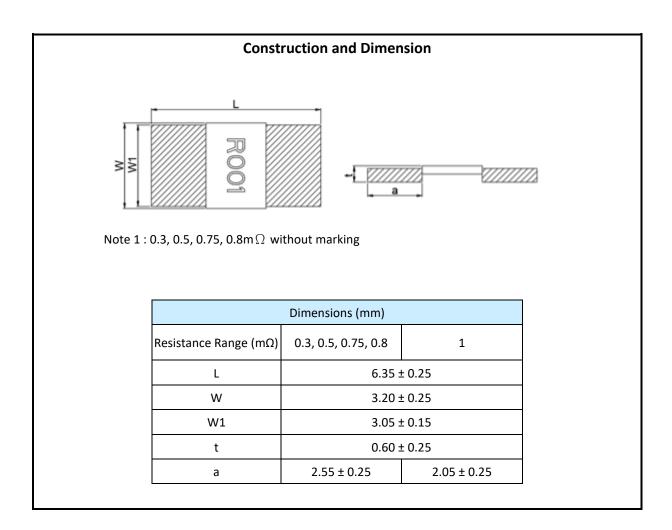
Figure 1. : Power derating curve at terminal temperature

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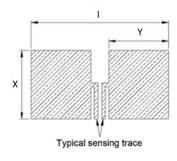
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## Outline Drawing:



#### **Recommended Solder Pad Dimensions**



Resistance Range	Dimensions			
mΩ	X (mm)	Y (mm)	I (mm)	
0.3 to 1	3.7	3.2	7.35	

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## Type Designation:

S C M M 2512 S - - - -

(1) (2) (3) (4) (5) (6)

Note:

(1) Series No.

(2) Size

(3) Terminal Type : S = Short terminal

(4) Power Rating: 6 = 6W

(5) Resistance value :  $R001 = 0.001\Omega$ ,  $OM50 = 0.0005\Omega$ 

(6) Tolerance :  $F = \pm 1\%$ ,  $G = \pm 2\%$ ,  $J = \pm 5\%$ 

# P/N list:

D/N	R value	TCR	Power Rating	Tolerance		
P/N	(mΩ)	(ppm/K)	(W)	1%	2%	5%
SCMM2512S6-0M30*	0.3	±125	6	✓		
SCMM2512S6-0M50*	0.5	±75	6	✓		
SCMM2512S6-0M75*	0.75	±75	6	✓		
SCMM2512S6-0M80*	0.8	±75	6	✓		
SCMM2512S6-R001*	1.0	±50	6	✓		

<sup>\*</sup> Note : Other values and tolerance would be available, please contact Cyntec.

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## Characteristics:

### Electrical

Item	Specification and Requirement	Test Method		
Temperature Coefficient (TCR)	As follow specification	JIS-C-5201 +25°C / +125°C.		
Short Time Overload	$\Delta R$ : $\pm$ 0.5% Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.13 2.5 x rated power for 5 seconds.		
Insulation Resistance	Over 100 M $\Omega$ on Overcoat layer face up	JIS-C-5201-1 4.6 100V <sub>DC</sub> for 60 +10/-0 seconds		
Voltage Proof	$\triangle R$ : $\pm$ 1% Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.7 400V <sub>AC</sub> (rms.) for 60 +10/ -0 seconds		

## Mechanical

Item	Specification and Requirement	Test Method		
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	J-STD-002 Method B category 3 245±5°C for 5±0.5 seconds.		
Resistance to Solder	△R: ± 0.5%	MIL-STD-202 Method 210		
Heat	Without distinct damage in appearance	260 $\pm$ 5°C for 10 $\pm$ 1 seconds.		
Board Flex	$\triangle$ R: $\pm$ 1.0% Without mechanical damage such as break.	AEC-Q200-005  Bending value: 2 mm for 60 ± 1 seconds.		
Vibration	$\triangle R$ : $\pm$ 0.5% Without distinct damage in appearance	MIL-STD-202 Method 204 5G's for 20 minutes, 12 cycles each of 3 orientations. Test from 10- 2000Hz.		

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Mechanical Shock	$\triangle R$ : $\pm$ 0.5% Without distinct damage in appearance	MIL-STD-202 Method 213 100G's peak value, 6ms, Half-sine waveform, 12.3ft/sec.
Terminal Strength (SMD)	$\triangle$ R: $\pm$ 1% Without mechanical damage such as break.	AEC-Q200-006 Force of 1.8Kg for 60 seconds.

#### Endurance

Item	Specification and Requirement	Test Method
Temperature Cycling	$\triangle$ R: $\pm$ 0.5% Without distinct damage in appearance	JESD22 Method JA-104 -55°C to 150°C /1000cycle 30 min maximum dwell time at each temperature on FR4(PCB).
Biased Humidity $\triangle R: \pm  0.5\%$ Without distinct damage in appearance		MIL-STD-202 Method 103 1000 hours, 85°C /85%R.H, applied for 10% rated power.
Operational Life	$\triangle$ R: $\pm$ 1.0% Without distinct damage in appearance	MIL-STD-202 Method 108 70°C, 100% rated power 1.5 hours ON, 0.5 hours Off For total 1000 hours
High Temperature $\triangle R: \pm 1.0\%$ Storage Without distinct damage in appearance		MIL-STD-202 Method 108 170°C for 1000 hours.
Moisture Resistance	$\triangle R$ : $\pm$ 0.5% Without distinct damage in appearance	MIL-STD-202 Method 106 65°C /90-100%RH, unpowered, 7b not required

Note : Measurement at 24 $\pm$ 4 hours after test conclusion for all reliability tests-parts.

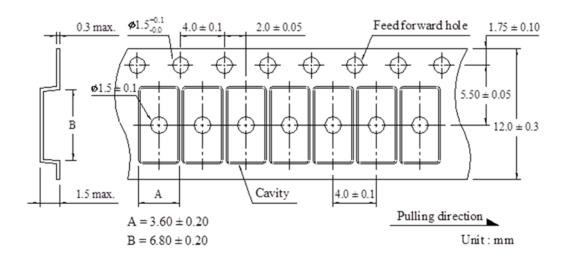
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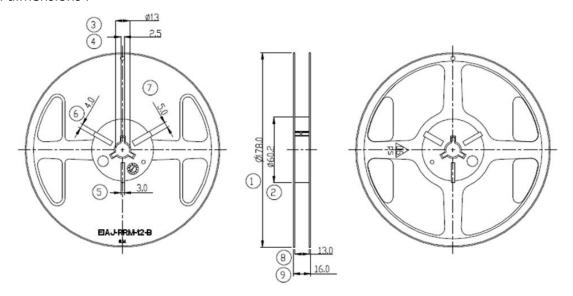


## PACKAGING DESCRIPTIONS:

### Dimensions:



### Reel dimensions:



Unit:mm

Symbol	1	2	3	4	5	6	7	8	9
Cino	178.0	60.2	13.0	2.5	3.0	4.0	5.0	13.0	16.0
Size	±1	±0.5	±0.5	+0.5/-0	+0.5/-0	+0.5/-0	+0.5/-0	±0.5	±0.15

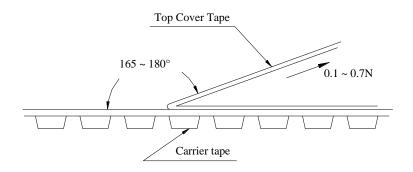
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## Peel Strength of Top Cover Tape:

The peel speed shall be about 300mm/min and the peel force of top cover tape shall between 0.1 to 0.7N



## Number of Taping:

2,000 pieces / reel

## Label Marking:

The following items shall be marked on tray

- (1) Description
- (2) Quantity
- (3) Part No.
- (4) Tapping No.

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#### Care Note:

#### Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity < 60% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen).
- (4) Expiration date: One year after shipping date (product is required to return after expiration date)
- (5) Solderability should be confirmed in case of exceeding 12 months.

#### Care note for operating and handling

- (1) Protect the edge and coating of the sensors from mechanical stress.
- (2) Avoid bending of printing circuit board (PCB) when cutting and fixing it on support body to reduce mechanical stress on sensors.
- (3) Sensor should be used within the condition of specification.
  Note: When a voltage higher than specified value is loaded to the sensor, this may damage the sensor material due to temperature rise.
- (4) The loaded voltage should consult terminal temperature of the sensor according to the derating curve.
- (5) When applying a high current exceeding suggested specification (pulse current, shock current) to the sensor, it is necessary to re-evaluate the operating condition before using it in the system.

(6)

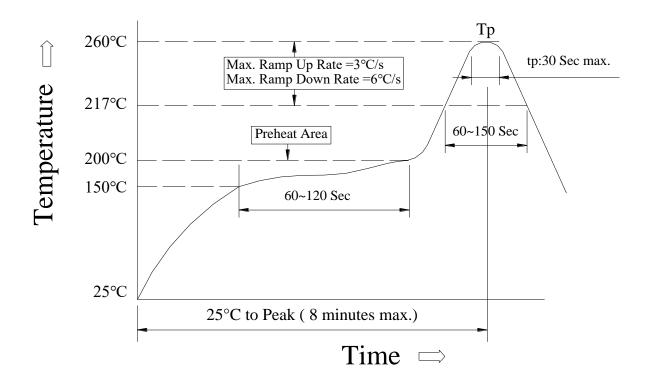
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## Reflow profile:

#### Recommended Reflow Profile



(1) Reflow Soldering Method:

Reflow Soldering	Tp:255~260°C	Max.30 seconds ( tp )
	217°C	60~150 seconds
Pre-Heat	150 ~ 200°C	60~120 seconds
Time 25°C to peak temperature	8 minutes max.	

Reference: JEDEC J-STD-020E

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